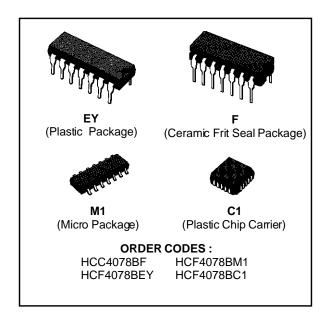


# HCC/HCF4078B

# 8-INPUT NOR/OR GATE

- MEDIUM-SPEED OPERATION t<sub>PHL</sub>, t<sub>PLH</sub> =75ns (TYP.) AT V<sub>DD</sub> = 10V
- QUIESCENT CURRENT SPECIFIED TO 20V FOR HCC DEVICE
- 5V, 10V, AND 15V PARAMETRIC RATINGS
- INPUT CURRENT OF 100nA AT 18V AND 25°C FOR HCC DEVICE
- 100% TESTED FOR QUIESCENT CURRENT
- MEETS ALL REQUIREMENTS OF JEDEC TEN-TATIVE STANDARD No. 13A, "STANDARD SPECIFICATIONS FOR DESCRIPTION OF "B" SERIES CMOS DEVICES"



# PIN CONNECTIONS K=A+B+C+D+ 1 +E+F+G+H A 2 B 3 C 4 D 5 NC 6 VSS 7 NC = NQ CONNECTION 5-2080/3

### **DESCRIPTION**

The **HCC4078B** (extended temperature range) and **HCF4078B** (intermediate temperature range) are monolithic integrated circuit, available in 14-lead dual in-line plastic or ceramic package, plastic micropackage.

The **HCC/HCF4078B** NOR/OR Gate provides the system designer with direct implementation of the positive-logic-8-input NOR and OR function and supplements the existing family of COS/MOS gates.

June 1989 1/11

# **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
V <sub>DD</sub> *	Supply Voltage : HCC Types HCF Types	- 0.5 to + 20 - 0.5 to + 18	V V
$V_{i}$	Input Voltage	- 0.5 to V <sub>DD</sub> + 0.5	V
$I_1$	DC Input Current (any one input)	± 10	mA
P <sub>tot</sub>	Total Power Dissipation (per package) Dissipation per Output Transistor for Top = Full Package-temperature Range	200	mW mW
Top	Operating Temperature : HCC Types HCF Types	- 55 to + 125 - 40 to + 85	°C
T <sub>stg</sub>	Storage Temperature	- 65 to + 150	°C

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for external periods may affect device reliability.

## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
$V_{DD}$	Supply Voltage : HCC Types HCF Types	3 to 18 3 to 15	V V
$V_{I}$	Input Voltage	0 to V <sub>DD</sub>	V
Top	Operating Temperature : HCC Types HCF Types	- 55 to + 125 - 40 to + 85	°C °C

 $<sup>^{\</sup>star}$  All voltage values are referred to  $V_{\text{SS}}$  pin voltage.

# STATIC ELECTRICAL CHARACTERISTICS (over recommended operating conditions)

			Т	est Con	dition	S				Value				
Symbol	ol Parameter		Vı	۷o	I <sub>0</sub>	V <sub>DD</sub>	ΤL	ow*		25°C		T <sub>Hi</sub>	g h *	Unit
			(V)	(V)	(μA)	(V)	Min.	Max.	Min.	Тур.	Max.	Min.	Max.	
ΙL	Quiescent		0/ 5			5		0.25		0.01	0.25		7.5	
	Current	нсс	0/10			10		0.5		0.01	0.5		15	
		Types	0/15			15		1		0.01	1		30	
			0/20			20		5		0.02	5		150	μΑ
			0/ 5			5		1		0.01	1		7.5	
		HCF Types	0/10			10		2		0.01	2		15	
		i ypes	0/15			15		4		0.01	4		30	
V <sub>OH</sub>	Output High	h	0/ 5		< 1	5	4.95		4.95			4.95		
	Voltage		0/10		< 1	10	9.95		9.95			9.95		V
			0/15		< 1	15	14.95		14.95			14.95		
V <sub>OL</sub>	Output Low	I	5/0		< 1	5		0.05			0.05		0.05	
	Voltage		10/0		< 1	10		0.05			0.05		0.05	V
			15/0		< 1	15		0.05			0.05		0.05	
V <sub>IH</sub>	Input High			0.5/4.5	< 1	5	3.5		3.5			3.5		
	Voltage			1/9	< 1	10	7		7			7		V
				1.5/13.5	< 1	15	11		11			11		
V <sub>IL</sub>	Input Low			4.5/0.5	< 1	5		1.5			1.5		1.5	
	Voltage			9/1	< 1	10		3			3		3	V
				13.5/1.5	< 1	15		4			4		4	
I <sub>OH</sub>	Output		0/ 5	2.5		5	- 2		- 1.6	- 3.2		- 1.15		
	Drive	HCC	0/ 5	4.6		5	- 0.64		- 0.51	- 1		- 0.36		
	Current	Types	0/10	9.5		10	- 1.6		- 1.3	- 2.6		- 0.9		
			0/15	13.5		15	- 4.2		- 3.4	- 6.8		- 2.4		A
			0/ 5	2.5		5	- 1.53		- 1.36	- 3.2		- 1.1		mA
		HCF	0/ 5	4.6		5	- 0.52		- 0.44	- 1		- 0.36		
		Types	0/10	9.5		10	- 1.3		- 1.1	- 2.6		- 0.9		
			0/15	13.5		15	- 3.6		- 3.0	- 6.8		- 2.4		
I <sub>OL</sub>	Output		0/ 5	0.4		5	0.64		0.51	1		0.36		
	Sink	HCC Types	0/10	0.5		10	1.6		1.3	2.6		0.9		
		i ypes	0/15	1.5		15	4.2		3.4	6.8		2.4		A
			0/ 5	0.4		5	0.52		0.44	1		0.36		mA
		HCF Types	0/10	0.5		10	1.3		1.1	2.6		0.9		
		1 ypes	0/15	1.5		15	3.6		3.0	6.8		2.4		
I <sub>IH</sub> , I <sub>IL</sub>	Input HCC Leakage Types 0/18		0/18	Any In	put	18		± 0.1		±10 <sup>-5</sup>	± 0.1		± 1	μΑ
	Current	HCF Types	0/15	, 111	r ***	15		± 0.3		±10 <sup>-5</sup>	± 0.3		± 1	F
Cı	Input Capa	citance		Any In	put					5	7.5			pF

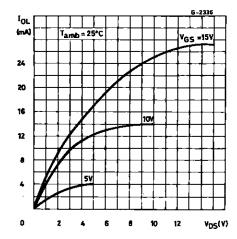
<sup>\*</sup>  $T_{Low} = -55^{\circ}\text{C}$  for HCC device :  $-40^{\circ}\text{C}$  for HCF device. \*  $T_{High} = +125^{\circ}\text{C}$  for HCC device :  $+85^{\circ}\text{C}$  for HCF device. The Noise Margin for both "1" and "0" level is : 1V min. with  $V_{DD} = 5V$ , 2V min. with  $V_{DD} = 10V$ , 2.5 V min. with  $V_{DD} = 15V$ .



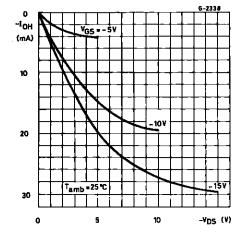
**DYNAMIC ELECTRICAL CHARACTERISTICS** ( $T_{amb} = 25^{\circ}C$ ,  $C_{L} = 50 pF$ ,  $R_{L} = 200 k\Omega$ , typical temperature coefficient for all  $V_{DD}$  values is  $0.3\%/^{\circ}C$ , all input rise and fall time = 20ns)

Cumbal	Davamatar	Test Conditions			Value		11:4
Symbol	Parameter		<b>V</b> <sub>DD</sub> (V)			Max.	Unit
t <sub>PHL</sub> , t <sub>PLH</sub>	Propagation Delay Time		5		150	300	
			10		75	150	ns
			15		55	110	
$t_{THL}, t_{TLH}$	Transition Time		5		100	200	
			10		50	100	ns
			15		40	80	

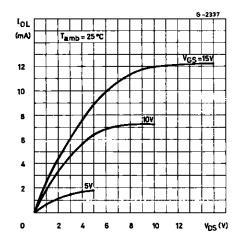
Typical Output Low (sink) Current Characteristics.



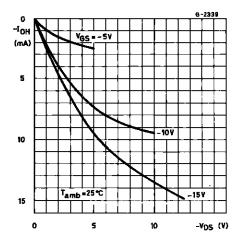
Typical Output High (source) Current Characteristics.



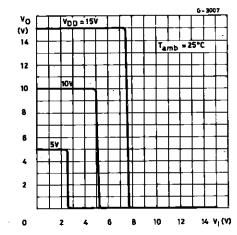
Minimum Output Low (sink) Current Characteristics.



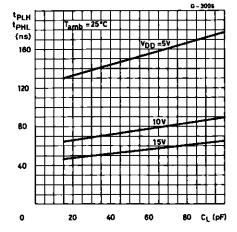
Minimum Output High (source) Current Characteristics.



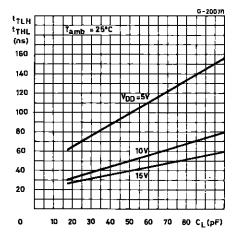
Typical Voltage Transfer Characteristics (NOR output).



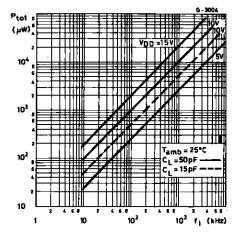
Typical Propagation Delay Time vs. Load Capacitance.



Typical Transition Time vs. Load Capacitance.

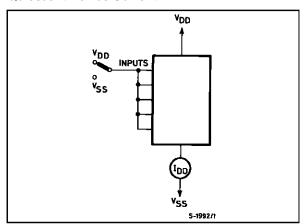


Typical Power Dissipation vs. Frequency.

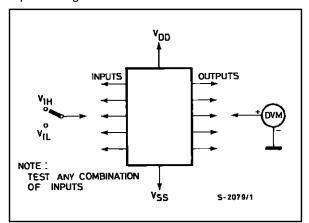


### **TEST CIRCUITS**

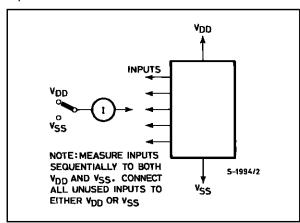
Quiescent Device Current.



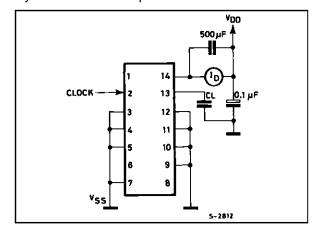
Input Voltage.



Input Current.

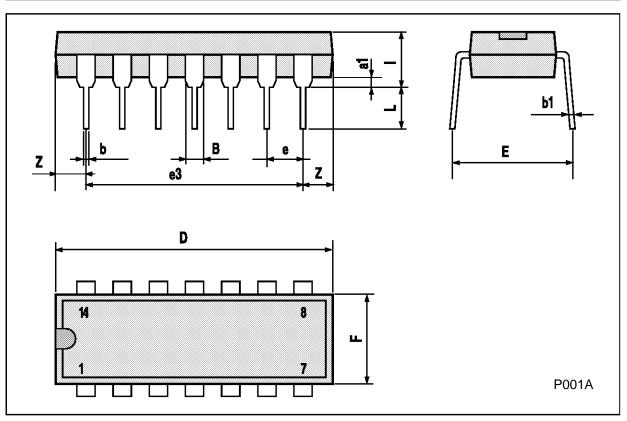


Dynamic Power Dissipation.



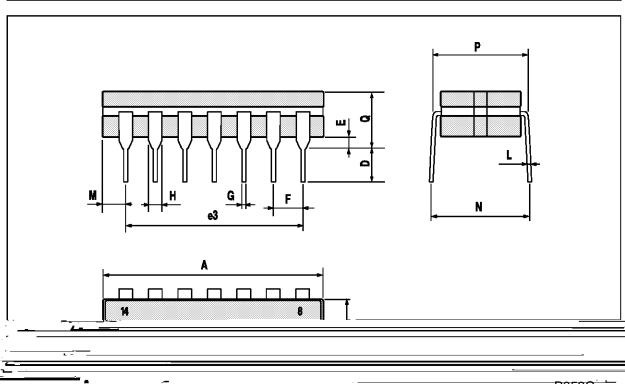
# Plastic DIP14 MECHANICAL DATA

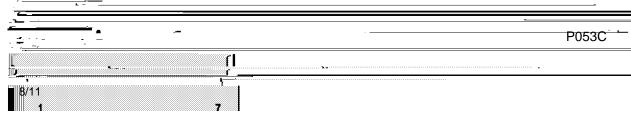
DIM.		mm			inch	
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
В	1.39		1.65	0.055		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
е		2.54			0.100	
e3		15.24			0.600	
F			7.1			0.280
I			5.1			0.201
L		3.3			0.130	
Z	1.27		2.54	0.050		0.100



# **Ceramic DIP14/1 MECHANICAL DATA**

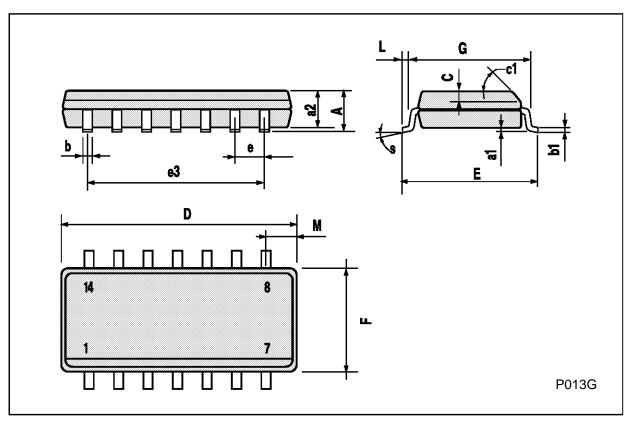
DIM.		mm			inch	
Diwi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А			20			0.787
В			7.0			0.276
D		3.3			0.130	
Е	0.38			0.015		
e3		15.24			0.600	
F	2.29		2.79	0.090		0.110
G	0.4		0.55	0.016		0.022
н	1.17		1.52	0.046		0.060
L	0.22		0.31	0.009		0.012
М	1.52		2.54	0.060		0.100
N			10.3			0.406
Р	7.8		8.05	0.307		0.317
Q			5.08			0.200





# **SO14 MECHANICAL DATA**

DIM.		mm			inch	
DIIVI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А			1.75			0.068
a1	0.1		0.2	0.003		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
С		0.5			0.019	
c1			45°	(typ.)		
D	8.55		8.75	0.336		0.344
E	5.8		6.2	0.228		0.244
е		1.27			0.050	
e3		7.62			0.300	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
М			0.68			0.026
S			8° (r	nax.)		



# PLCC20 MECHANICAL DATA

DIM.		mm			inch	
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	9.78		10.03	0.385		0.395
В	8.89		9.04	0.350		0.356
D	4.2		4.57	0.165		0.180
d1		2.54			0.100	
d2		0.56			0.022	
E	7.37		8.38	0.290		0.330
е		1.27			0.050	
e3		5.08			0.200	
F		0.38			0.015	
G			0.101			0.004
М		1.27			0.050	
M1		1.14			0.045	



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